IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	Docket No.:
Yoshitsugu MORITA et al.	71,051-031
Serial No.:	Group Art Unit:
10/578,798	unknown
Filed:	Confirmation No.:
May 5, 2006	8735
For: Curable Silicone Composition And Cured Product Thereof	I hereby certify that the enclosed information Disclosure Statement is being transmitted via EFS transmission to the Commissioner of Patents, PO BOX 1450, Alexandria, VA 22313-1450, on the date shown below.
	01/12/07 (Sandra Barry) Date Sandra Barry
Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450	
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The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made (37 C.F.R. 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability and/or examination, or that no other material information exists. The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner

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	i.C. §120, this app					
], filed on [
	Office on this prior	application ar	d are therefo	re not require	d to be provide	ad in this

Information Disclosure Statement Page 2				
In accordance with 37 C.F.R. §1.98(c), a copy of only [] is being submitted with this Information Disclosure Statement, and is cumulative of the following patients or publications listed on Form PTIOSE09a:				
FOREIGN LANGUAGE DOCUMENTS				
There are no foreign language de	ocuments listed on Form	PTO/SB/08a.		
English language abstract for the following non-English references are enclosed:				
		Name of Patentee or Applicant of		
Foreign Patent Document	Publication Date	Cited Document		
JP6-306084	11/01/1994	Shiobara et al.		
JP7-118365	05/09/1995	Sakamoto et al.		
JP7-022441	01/24/1995	Sakamoto et al.		
JP10-130465	05/19/1998	Takeda et al.		
JP10-147764	06/02/1998	Takeda et al.		
JP10-163232	06/19/1998	Takeda et al.		
Submitted herewith is an English translation of the following foreign language patients, publications or information or of portions of those patients, publications or information considered to be material: No English language translations of the foreign language patients, publications or information or parts thereof are readily available, except for those listed above. The following foreign language documents are believed to be the equivalent or substantial equivalent of the English language documents Mertilified below, which are also submitted herewith:				
Cited Art	English	Equivalent		

Document JP 6-306084	Explanation of Relevance The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document disclose an epoxy resin correposition consisting of a specific peapy-motified a silicon and a specific modified silicone that is capable of providing a cured product.
JP7-118365	The relevancy of this document as presently understood is obtained from

Foreign Patent

The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses a die-bonding material obtained by mixing a reaction product of a specific epoxy resin with a phenol with an epoxy resin, a curing agent, and an

Information Disclosure Statement Page 3 inorganic filler. .IP7-022441 The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses an epoxy-based die bonding material including an epoxy resin containing a specific equivalent ration between the epoxy resin and bisphenol group, a curing agent, and inorganic filler. ID10-130465 The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses a die-attaching paste obtained by blending an epoxy resin, a reaction product of a specific epoxy resin with a bisphenol compound, a curing agent, a specific cyanic acid ester or a prepolymer thereof, and an ingroanic filler. JP10-147764 The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses a die attach paste comprising an epoxy resin, a curing agent, an inorganic filler, and a cure accelerator. The epoxy resin is an epoxy dimethylsiloxane compound, and the die attach paste is used to obtain semiconductor devices .IP10-163232 The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses a die attaching paste that includes an epoxy resin, a hardner, and a mineral filler. The epoxy resin is readed in advance with a cyanate resin to provide a polymer. A concise explanation of the relevance of the following listed non-English language information is set forth in the above-identified specification: CERTIFICATION: X The Information Disclosure Statement transmitted herewith is being filed within three (3) months of the filing date of the application or date of entry into the national stage of an international application or before the mailing date of a first Office Action on the merits. whichever event occurs last. 37 C.F.R. \$1.97(b). Accordingly, it is believed that no certification or fee is due. The Information Disclosure Statement transmitted herewith is being filed after three (3) months of the filing date of the application or the date of entry into the national stage of an international application or after the mailing date of the first Office Action on the merits, whichever event occurred last but before the mailing date of either a final action under 37 C.F.R. \$1.113 or a Notice of Allowance under 37 C.F.R. 61.311, whichever occurs first. Accordingly, I hereby certify that: each item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three (3) months prior to the filing of the Information Disclosure Statement: 37 C F B &1.97(e)(1): OR

no item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patient office in a contemptant proleign application, and, to my knowledge as the person signing this certification after making reasonable inquiry, on item of information contained in the Information Disclosure Statement was known van jindvidual designated in \$1.56(c) more than three (3) months prior to the filing of this statement; 37 CF. R 8.197(c)(2) OR

Information Disclosure Statement Page 4				
an Information Disclosure Staten	the fee set forth in 37 C.F.R. §1.17(p) for submission of nent under 37 C.F.R. §1.97(c). If a check is not enclosed, submission fee to Howard & Howard Attorneys PC Deposit te of this paper is enclosed.			
The Information Disclosure Statement transmitted hercetift is being filed After a Final Action under 37 C.F.R.§ 11.1, or After a Notice of Allowance under 37 C.F.R.§ 11.1, whicheo occurs first, but is being filed on or Before Payment of the Issue Fee. Accordingly, I hereby certify that:				
cited in a communication from a	ed in the Information Disclosure Statement was foreign patent office in a counterpart foreign application not to the filing of the statement; 37 C.F.R. §1.97(e)(1); OR			
in a communication from a foreign my knowledge as the person significant of information contained in	in the Information Disclosure Statement was cited an patent office in a counterpart foreign application, and, to gning this certification after making reasonable inquiry, no the Information Disclosure Statement was known to any o) more than three (3) months prior to the filing of this AND			
C.F.R. §1.97(d)(2)(ii). If a check	sideration of this Information Disclosure Statement; 37 is not enclosed, please charge the petition fee of \$180.00 Deposit Account No. 08-2789. A duplicate of this paper is			
The Commissioner is authorized to ch 08-2789 for any additional fees due hereunder	narge Howard & Howard Attorneys PC Deposit Account No.			
	Respectfully submitted			
Reg. No.: 46,295	/David M. LaPrairie/ David M. LaPrairie			
<u>January 12, 2007</u> Date	Howard & Howard Attorneys PC The Pinehurst Office Center, Suite 101 39400 Woodward Avenue Bloomfield Hills, MI 48304-5151 Tel. No.: (248) 723-0442			

Customer No. 27305